

# **DATASHEET**

# ELDA06-HB2555J3J8283910-FCX

# Received MASS PRODUCTION PRELIMINARY CUSTOMER DESIGN DEVICE NO.: DHE-0003497 PAGE: 13

Revised record					
REV.	DESCRIPTION	RELEASE DATE			
1	New spec.	2018.05.04			



# ELDA06-HB2555J3J8283910-FCX



### **Features**

• Feature of the device : small package with high efficiency

• CW Typical luminous flux @ 1A: 220 lm

• CW Optical efficiency@1A: 67.65lm/W

• WW Typical luminous flux@ 1A: 170 lm

• WW Optical efficiency@1A: 50 lm/W

- ESD protection (according to JEDEC 3b) (HBM air or contact discharge)up to 8KV
- Binning Parameters: Brightness, Forward Voltage and Chromaticity
- Grouping parameter: total luminous flux, color coordinates.
- Pb free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

# **Applications**

- Mobile Phone Camera Flash(Camera flash light /strobe light for mobile devices)
- Torch light for DV(Digital Video) application
- Indoor lighting applications
- Signal and symbol luminaries for orientation maker lights (e.g. steps, exit ways, etc.)
- TFT backlighting
- Exterior and interior illumination applications
- Decorative and Entertainment Lighting
- Exterior and interior automotive illumination



# **Device Selection Guide**

Chip Materials	Emitted Color
InGaN	Dual Color

# **Absolute Maximum Ratings**

Parameter	Symbol	Rating	Unit
DC Forward Current (Torch Mode) (6)	l <sub>F</sub>	350	mA
Peak Pulse Current (6) (200 ms on / 1800 ms off / 2000 cycle )	Pulse	1000	mA
ESD Resistance (JEDEC 3b)	$V_{B}$	8000	V
Reverse Voltage	$V_{R}$	Note 1	V
Junction Temperature	TJ	125	$^{\circ}\!\mathbb{C}$
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	TStg	-40 ~ +100	$^{\circ}\! \mathbb{C}$
Soldering Temperature	TSol	260	$^{\circ}\mathrm{C}$
Allowable Reflow Cycles	n/a	2	Cycles
Viewing Angle <sub>(2)</sub>	2θ <sub>1/2</sub>	120	Deg
Power Dissipation (Pulse Mode)-CW	$P_d$	5.9	W
Power Dissipation (Pulse Mode)-WW	Pd	5.9	W

- 1. The DA series LEDs are not designed for reverse bias used.
- 2. View angle measurement tolerance±5°
- 3. Avoid operating DA series LEDs at maximum operating temperature exceed 1 hour.
- **4.** All specification are assured by reliability test for 1000hr, IV degradation less than 30%.
- 5. All reliability items are tested under good thermal management with 1.5x 1.5 cm<sup>2</sup> MCPCB.
- 6. Test item by single chip(Cold white or Warm white) with 1.5x 1.5 cm<sup>2</sup> MCPCB.



# Electro-Optical Characteristics (Ts=25°C)-Warm White

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux(1)	lv	140	170		lm	
Forward Voltage(2)(3)	VF	2.85		3.95	V	1 4000 m A
Color Temperature	CCT	2250		2750	К	- I <sub>F</sub> =1000mA
Color Rendering Index	CRI	90	93			-

# Electro-Optical Characteristics (Ts=25°C)-Cold White

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux(1)	lv	190	220		lm	_
Forward Voltage(2)(3)	$V_{F}$	2.85		3.95	V	I1000m A
Color Temperature	ССТ	5000		6000	K	- I <sub>F</sub> =1000mA
Color Rendering Index	CRI	90	93			-

**Forward Voltage Binning** 

Bin	Symbol	Min.	Тур.	Max.	Unit	Condition
2835	VF	2.85		3.55		
3539	V <sub>F</sub>	3.55		3.95	V	I <sub>F</sub> =1000mA

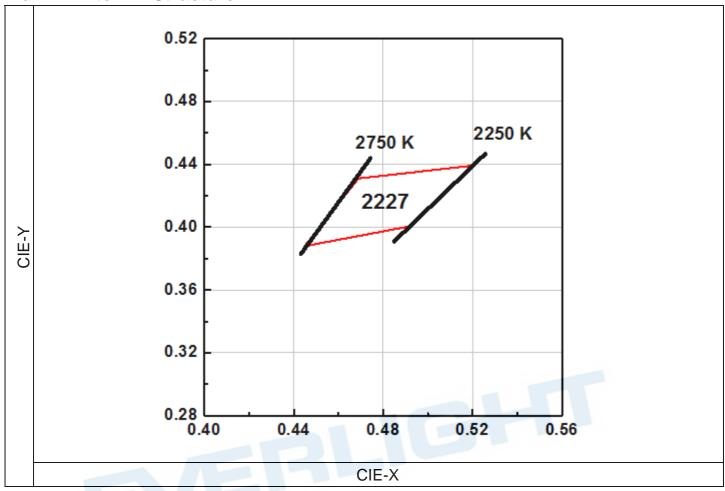
**Luminous Flux Binning** 

Bin	Symbol	Min.	Тур.	Max.	Unit	Condition
J3	lv	140		160		
J45	lv	160		190		I <sub>F</sub> =1000mA
J56	lv	190		250	– lm	IF=TOOOMA
J78	lv	250		330	_	

- 1. Luminous Flux, illuminance measurement tolerance: ±10%
- 2. Forward voltage measurement tolerance: ±0.1V
- 3. Electric and optical data is tested at 50 ms pulse condition.
- 4. Low current voltage measurement tolerance: ±10%
- 5. Temperature of solder pad : 25°C



# **Warm White Bin Structure**

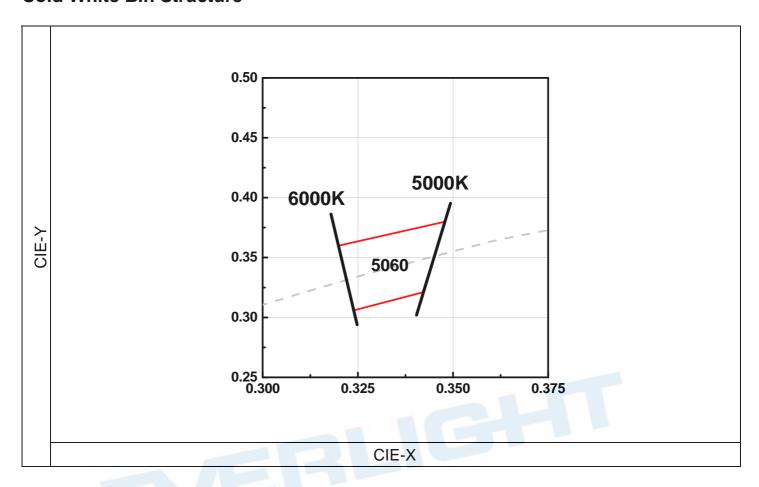


Bin	CIE-X	CIE-Y	Reference Range
	0.4690	0.4310	
0007	0.5200	0.4390	00501/ 07501/
2227	0.4920	0.4010	2250K ~2750K
	0.4450	0.3880	

- 1. Color coordinates measurement allowance : ±0.01
- 2. Color bins are defined at IF=1000mA operation.



# **Cold White Bin Structure**

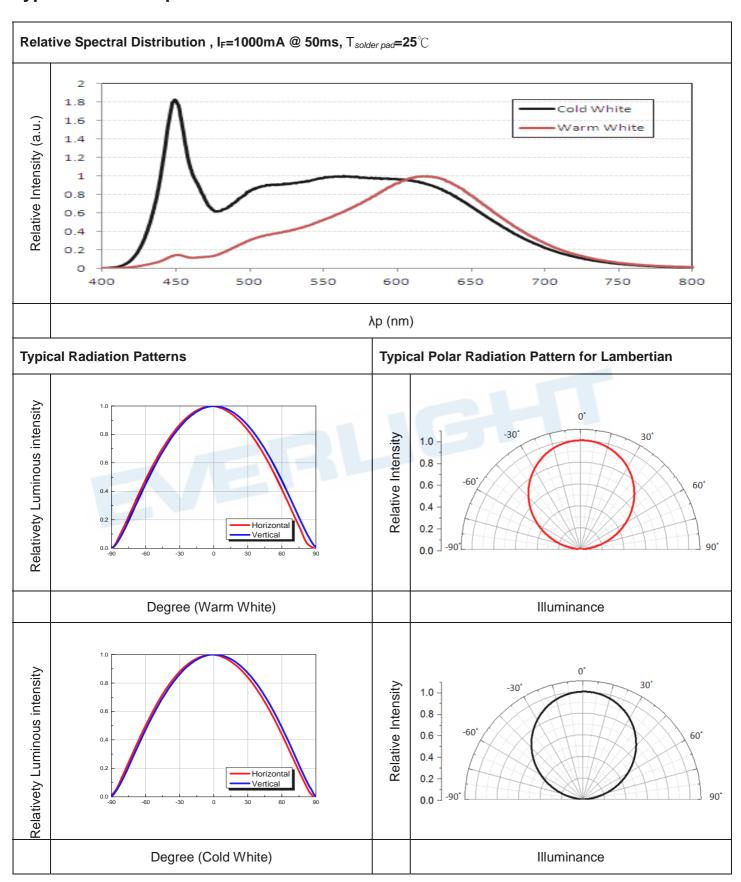


Bin	CIE-X	CIE-Y	Reference Range	
	0.3200	0.3600		
5060	0.3480	0.3800	5000 000014	
	0.3420	0.3210	5000 ~ 6000K	
	0.3240	0.3060		

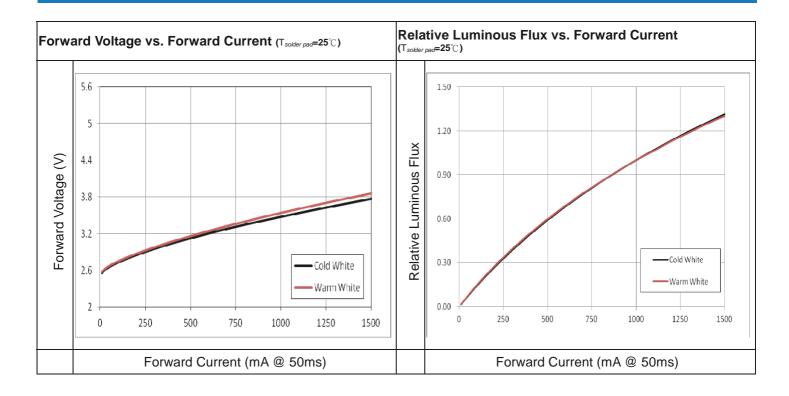
- 1. Color coordinates measurement allowance: ±0.01
- 2. Color bins are defined at IF=1000mA operation.

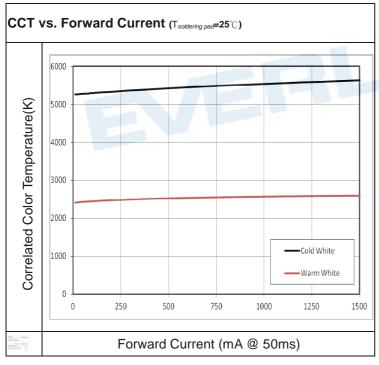


# **Typical Electro-Optical Characteristics Curves**





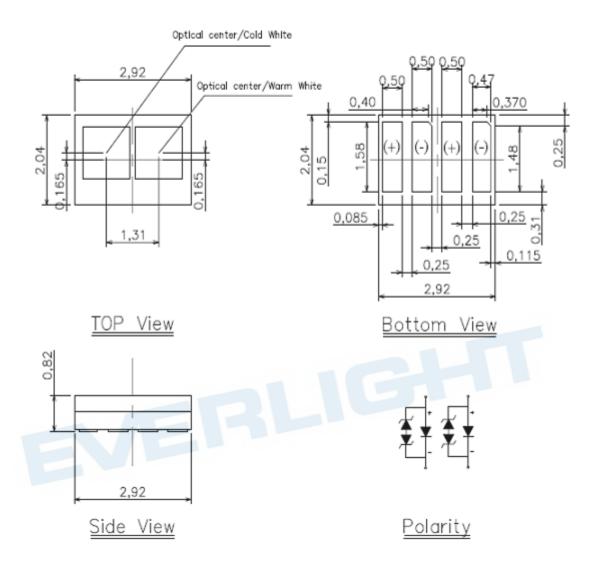




- 1.  $2\theta 1/2$  is the off axis from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is  $\pm 5^{\circ}$
- 3. All correlation data is tested under superior thermal management with 1 .5x 1.5 cm2 MCPCB.



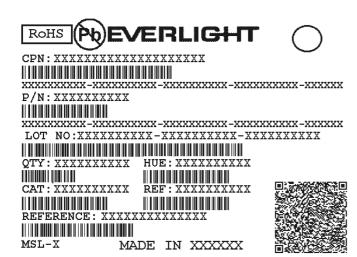
# **Package Dimension**



- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are  $\pm$  0.1mm.



# **Moisture Resistant Packing Materials Product Labeling**



CPN: Customer's Product NumberP/N: Everlight Product Number

• QTY : Packing Quantity

· CAT: Luminous Flux (Brightness) Bin

• HUE: Color Bin

· REF: Forward Voltage Bin

· LOT No: Lot Number

# Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel

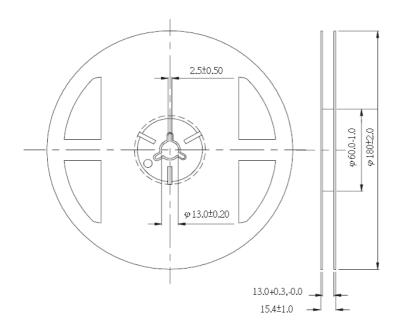
(Minimum Package Quantity:1000 PCS)

# **Progress Direction** 2.00 ±.05 Ø 1.50 +.10 8.00 ±0.10 1.75 ±0.10 4.00 ±0.20 ⊕ 3.50 ±.05 Cold White B.00 +.30 \_.10 ф ф Warm White 1.00 ±0.10 .25 ±0.05 Pola<u>rity</u> 2.18 ±0.05 1.00 ±0.05 3.18 ±0.05

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ±0.1mm.



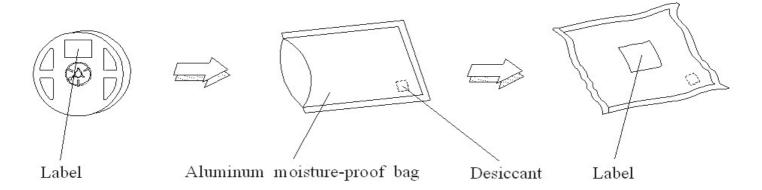
## **Emitter Reel Dimensions**



### Notes:

1. Dimensions are in millimeters.

# **Moisture Resistant Packing Process**





# **Reflow Soldering Characteristics**

### **Soldering and Handling**

### 1. Over-current-proof

Though DA series has conducted ESD protection mechanism, customers must not use the device in reverse and should apply resistors for extra protection. Otherwise, slight voltage shift may cause enormous current shift and burn out failure would happen.

### 2. Storage

- 2.1 Do not open the moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 90%
- 2.3 After opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 85%.
- 1.4 If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be implemented based on the following conditions: Pre-curing at 60±5°C for 24 hours.

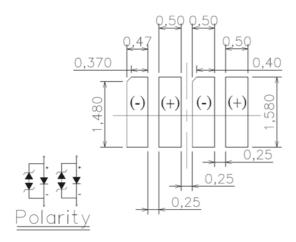
### 3. Thermal Management

- 3.1 For maintaining the high flux output and achieving reliability, DA series LEDs should be mounted on a metal core printed circuit board (MCPCB), with proper thermal connection to dissipate approximately 1W to 5W of thermal energy under normal operation.
- 3.2 Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LEDs lifetime will decrease critically.
- 3.3 When operating , the solder pad temperature ( or the board temperature nearby the LED) must controlled under  $70^{\circ}$ C.



### 4. Soldering Condition

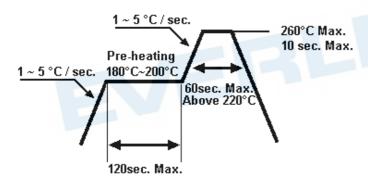
### 4.1 Soldering Pad



Recommended Soldering Pad

### 4.2 For Reflow Process

4.2.1 Lead reflow soldering temperature profile



- 4.2.2 Reflow soldering should not be done more than two times.
- 4.2.3 While soldering, do not put stress on the LEDs during heating.
- 4.2.4 After soldering, do not warp the circuit board.



### **DISCLAIMER**

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets EVERLIGHT published specification for a period of twelve (12) months from dat shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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>>Everlight(亿光)